

SIITME 2026

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Design and Technology in Electronics Packaging
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Conference & Exhibition



Workshop/Panel speaker:

Name: Denis Cosmin Oncioiu

Job position: Software Developer

Company: *Infineon Technologies Romania*

Ph.D. Student at University POLITEHNICA of Bucharest

Chair of IEEE Student Branch Chapter EPS

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Short CV

I graduated from the Faculty of Electronics, Telecommunications and Information Technology (ETTI), National University of Science and Technology Politehnica Bucharest, with a Bachelor's diploma project on a robot that solves the Rubik's cube, and continued with a Master's degree at the same faculty, in the automotive specialization. My Master's dissertation project, eModule, is a modular electronics kit for educational applications, which I continue to develop through eModule.ro. Since 2023 I have been working as a software developer at Infineon, on a GUI application and on the embedded code for the boards that communicate with it. I have been a member of the IEEE Student Branch Chapter EPS since 2021 and I am currently its Chair. I competed in the TIE contest and, for the last two years, I have been a grader and have prepared students for it. I am co-author of two IEEE papers, on a 3D-printed modular electronics kit for education and on a temperature monitoring system for electric vehicles in maritime transport.